N-Channel 100V, 1.07mΩ Typ. Power MOSFET

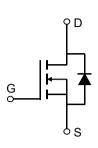
Description

Features

• 100V, 430A

 $R_{DS(ON)}$ Typ = 1.07m Ω @ V_{GS} = 10V Advanced Split Gate Trench Technology

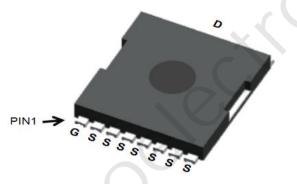
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

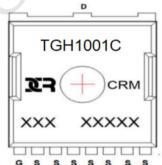




Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMTGH1001C	CRMTGH1001C	TOLL	TAPING	13"	2000	10000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		100	V
V_{GS}	Gate-to-Source Voltage		±20	V
I _D	Continuous Drain Current	T _C = 25°C	430	Α
	Continuous Drain Current	T _C = 100°C	258	Α
I _{DM}	Pulsed Drain Current (1)		1720	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		1106	mJ
P_{D}	Power Dissipation	T _C = 25°C	463	W
$R_{ hetaJC}$	Thermal Resistance, Junction to Case		0.27	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C

N-Channel 100V, 1.07mΩ Typ. Power MOSFET

Electrical Characteristics (T_J = 25°C unless otherwise specified)

x. Uni V μA 0 nA V pF
μΑ 0 nA 5 V mΩ
μΑ 0 nA 5 V mΩ
0 nA V mΩ
y mΩ
mΩ pF
mΩ pF
pF
•
•
pF
pF
nC
nC
nC
ns
ns
ns
ns
) A
0 A
. V
ns
nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =50V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =66.5A

^{3.} Pulse Test: Pulse Width $\!\!\!\!<\!300\mu s,$ Duty Cycle $\!\!\!<\!0.5\%.$



N-Channel 100V, 1.07mΩ Typ. Power MOSFET

Typical Performance Characteristics

Figure 1: Output Characteristics

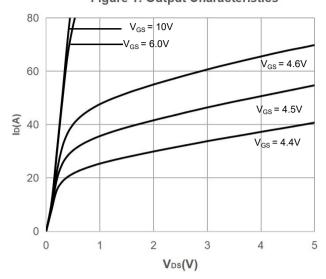


Figure 3: On-resistance vs. Drain Current

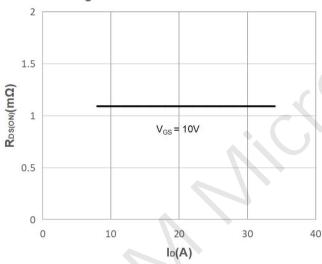


Figure 5: Gate Charge Characteristics

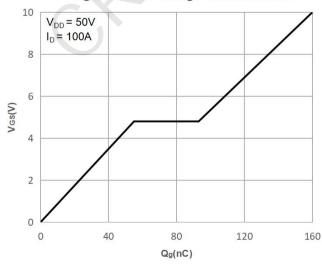


Figure 2: Typical Transfer Characteristics

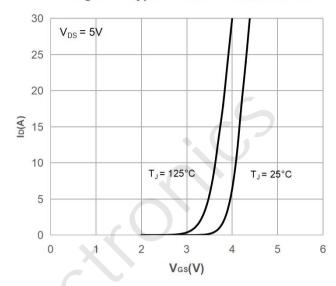


Figure 4: Body Diode Characteristics

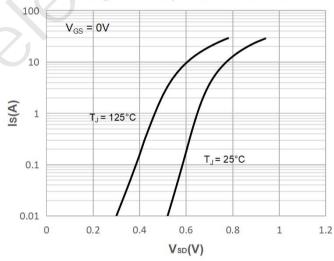
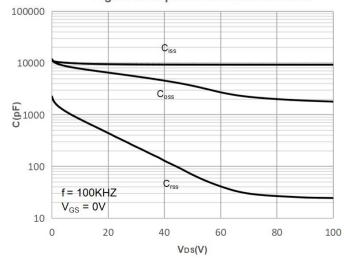


Figure 6: Capacitance Characteristics



N-Channel 100V, 1.07mΩ Typ. Power MOSFET

Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

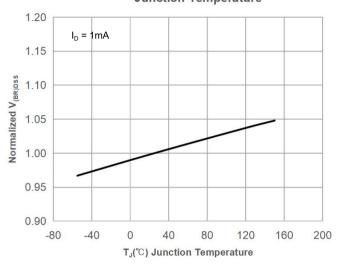


Figure 9: Maximum Safe Operating Area

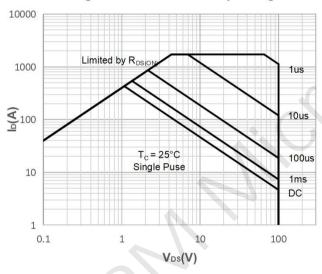


Figure 11: Normalized Maximum Transient

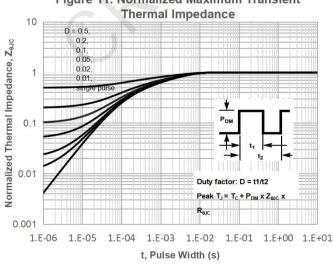


Figure 8: Normalized on Resistance vs. Junction Temperature

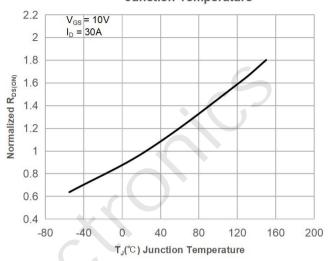


Figure 10: Maximum Continuous Drian
Current vs. Case Temperature

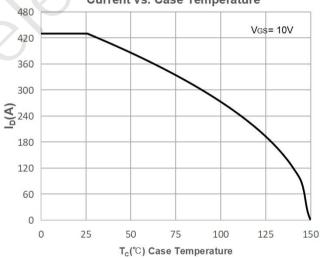
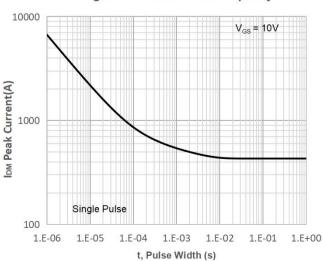


Figure 12: Peak Current Capacity



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Test Circuit

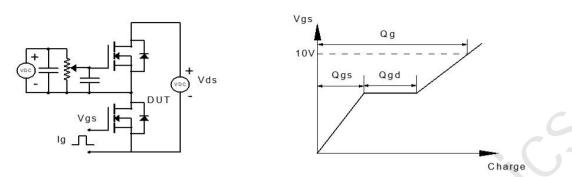


Figure 1: Gate Charge Test Circuit & Waveform

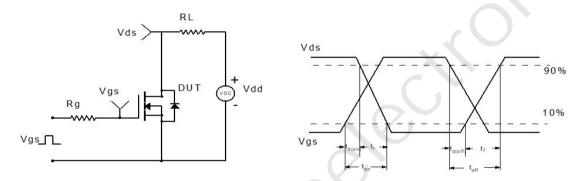


Figure 2: Resistive Switching Test Circuit & Waveform

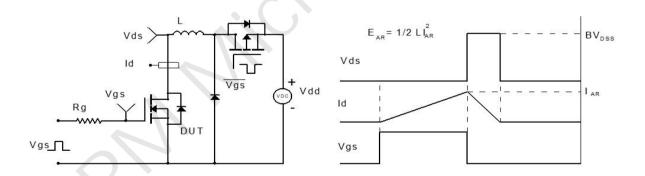


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

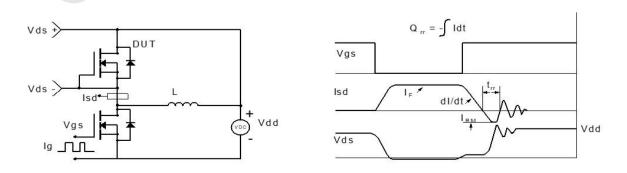


Figure 4: Diode Recovery Test Circuit & Waveform

MAX

2.40

9.95

1.70

10.60

9.85

11.80

0.75

0.75

0.55

0.80

0.80

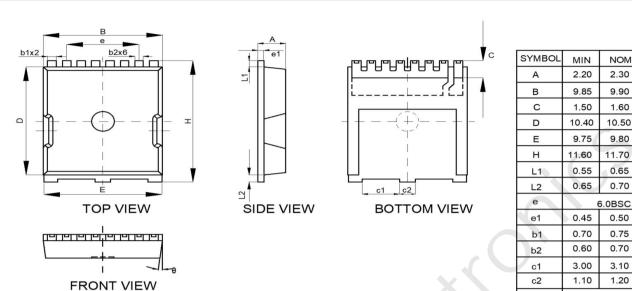
3.20

1.30

11°

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Package Mechanical Data(TOLL)



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